

3/3/2016



**PRODUCT RELIABILITY REPORT
FOR**

MAX32620

Maxim Integrated

**14460 Maxim Dr.
Dallas, TX 75244**

Approved by:

**Sokhom Chum
MTS, Reliability Engineering**

Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim Integrated products:

MAX32620

In addition, Maxim Integrated's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at <http://www.maximintegrated.com/qa/reliability/monitor>.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at <http://www.maximintegrated.com/search/parts.mvp>.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

$$AfT = \exp((Ea/k) * (1/Tu - 1/Ts)) = tu/ts$$

AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10⁻⁵ eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 eV)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7eV will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

$$AfV = \exp(B * (Vs - Vu))$$

AfV = Acceleration factor due to Voltage
Vs = Stress Voltage (e.g. 7.0 volts)
Vu = Maximum Operating Voltage (e.g. 5.5 volts)
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

$$Fr = X / (ts * AfV * AfT * N * 2)$$

X = Chi-Sq statistical upper limit
N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

$$MTTF = 1/Fr$$

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: **MTTF (YRS):** **51617** **FITS:** **2.2**
DEVICE HOURS: **414314450** **FAILS:** **0**

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% **Ea: 0.7** **B: 0** **Tu: 25 °C** **Vu: 3.6 Volts**

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Information:

Process: TSMC 90nm Low Power, Embedded flash
Passivation: SiO/SiN = 400nm/600nm
Die Size: 154 x 154
Number of Transistors: 17787494
Interconnect: Aluminum / 0.5% Copper

ESD HBM

DESCRIPTION	DATE	CODE/PRODUCT/LOT	CONDITION	READPOIN	QTY	FAILS	FA#
ESD SENSITIVITY	1530	MAX32620	Z4159935GC JESD22-A114 HBM 500 VOLTS	1	PUL'S	5	0
ESD SENSITIVITY	1530	MAX32620	Z4159935GC JESD22-A114 HBM 1000 VOLTS	1	PUL'S	5	0
ESD SENSITIVITY	1530	MAX32620	Z4159935GC JESD22-A114 HBM 1500 VOLTS	1	PUL'S	5	0
ESD SENSITIVITY	1530	MAX32620	Z4159935GC JESD22-A114 HBM 2000 VOLTS	1	PUL'S	5	5 No FA
ESD SENSITIVITY	1530	MAX32620	Z4159935GC JESD22-A114 HBM 2500 VOLTS	1	PUL'S	5	5 No FA
Total:						10	

LATCH-UP

DESCRIPTION	DATE	CODE/PRODUCT/LOT	CONDITION	READPOIN	QTY	FAILS	FA#
LATCH-UP I	1530	MAX32620	Z4159935GC JESD78A, I-TEST 25C 100mA			6	0
LATCH-UP I	1530	MAX32620	Z4159935GC JESD78A, I-TEST 25C 250mA			6	0
LATCH-UP V	1530	MAX32620	Z4159935GC JESD78A, V-SUPPLY TEST 25C			6	0
Total:						0	

OPERATING LIFE

DESCRIPTION	DATE	CODE/PRODUCT/LOT	CONDITION	READPOIN	QTY	FAILS	FA#
HIGH TEMP OP LIFE	1404	MAX71637	ZN144839AC 125C, 3.6V (PSA) & 3.8V (PSB)	240 HRS	80	0	
HIGH TEMP OP LIFE	1432	MAX71637	ZN144839AA 125C, 3.6V (PSA) & 3.8V (PSB)	1000 HRS	80	0	
HIGH TEMP OP LIFE	1432	MAX71637	ZN148158AB 125C, 3.6V (PSA) & 3.8V (PSB)	1000 HRS	80	0	
HIGH TEMP OP LIFE	1432	MAX71637	ZN148159AB 125C, 3.6V (PSA) & 3.8V (PSB)	1000 HRS	79	0	
HIGH TEMP OP LIFE	1437	MAX32550	ZX158472AA 125C, 3.6V (PSA) & 5.5V (PSB)	192 HRS	80	0	
HIGH TEMP OP LIFE	1441	MAX79356	ZNB00036AA 125C, 3.6 VOLTS	192 HRS	80	0	
HIGH TEMP OP LIFE	1530	MAX32620	Z4159935GC 125C, 1.89V (V5), 1.26V (V6), 3.6V (V1)	1000 HRS	45	0	
HIGH TEMP OP LIFE	1531	MAX32550	ZX150216AB 125C, 3.6V (PSA) & 5.5V (PSB)	192 HRS	80	0	
HIGH TEMP OP LIFE	1532	MAX32620	Z4159935AA 125C, 1.89V (V5), 1.26V (V6), 3.6V (V1)	1000 HRS	45	0	
HIGH TEMP OP LIFE	1532	MAX32620	Z4159935GA 125C, 1.89V (V5), 1.26V (V6), 3.6V (V1)	1000 HRS	45	0	

Total: 0

FAILURE RATE: MTTF (YRS): 51617 FITS: 2.2
DEVICE HOURS: 414314450 FAILS: 0

MAX32621 is built with the identical die of MAX32620.